

# SEMiX452GB176HDs



SEMiX® 2s

## Trench IGBT Modules

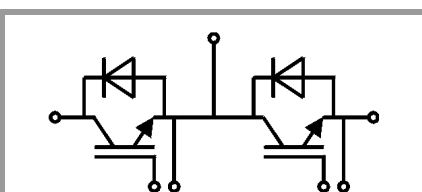
### SEMiX452GB176HDs

#### Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$  with positive temperature coefficient
- UL recognised file no. E63532

#### Typical Applications\*

- AC inverter drives
- UPS
- Electronic welders



GB

| Absolute Maximum Ratings |   |                       |                    |               |
|--------------------------|---|-----------------------|--------------------|---------------|
| Symbol                   | Conditions  | Values                | Unit               |               |
| <b>IGBT</b>              |   |                       |                    |               |
| $V_{CES}$                | $T_j = 25\text{ °C}$  | 1700                  | V                  |               |
| $I_C$                    | $T_j = 150\text{ °C}$   | $T_c = 25\text{ °C}$  | 437                | A             |
|                          |   | $T_c = 80\text{ °C}$  | 310                | A             |
| $I_{Cnom}$               |   | 300                   | A                  |               |
| $I_{CRM}$                | $I_{CRM} = 2 \times I_{Cnom}$   | 600                   | A                  |               |
| $V_{GES}$                |   | -20 ... 20            | V                  |               |
| $t_{psc}$                | $V_{CC} = 1000\text{ V}$<br>$V_{GE} \leq 20\text{ V}$<br>$V_{CES} \leq 1700\text{ V}$ | $T_j = 125\text{ °C}$ | 10                 | $\mu\text{s}$ |
|                          |   |                       |                    |               |
| $T_j$                    |   | -55 ... 150           | $^{\circ}\text{C}$ |               |
| <b>Inverse diode</b>     |   |                       |                    |               |
| $I_F$                    | $T_j = 150\text{ °C}$   | $T_c = 25\text{ °C}$  | 389                | A             |
|                          |   | $T_c = 80\text{ °C}$  | 262                | A             |
| $I_{Fnom}$               |   | 300                   | A                  |               |
| $I_{FRM}$                | $I_{FRM} = 2 \times I_{Fnom}$   | 600                   | A                  |               |
| $I_{FSM}$                | $t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 25\text{ °C}$                            | 2000                  | A                  |               |
| $T_j$                    |   | -40 ... 150           | $^{\circ}\text{C}$ |               |
| <b>Module</b>            |   |                       |                    |               |
| $I_{t(RMS)}$             | $T_{terminal} = 80\text{ °C}$   | 600                   | A                  |               |
| $T_{stg}$                |   | -40 ... 125           | $^{\circ}\text{C}$ |               |
| $V_{isol}$               | AC sinus 50Hz, $t = 1\text{ min}$   | 4000                  | V                  |               |

| Characteristics |  |                       |      |       |                  |
|-----------------|--|-----------------------|------|-------|------------------|
| Symbol          | Conditions   | min.                  | typ. | max.  | Unit             |
| <b>IGBT</b>     |  |                       |      |       |                  |
| $V_{CE(sat)}$   | $I_C = 300\text{ A}$<br>$V_{GE} = 15\text{ V}$<br>chipelevel | $T_j = 25\text{ °C}$  | 2    | 2.45  | V                |
|                 |  | $T_j = 125\text{ °C}$ | 2.5  | 2.9   | V                |
| $V_{CE0}$       |  | $T_j = 25\text{ °C}$  | 1    | 1.2   | V                |
|                 |  | $T_j = 125\text{ °C}$ | 0.9  | 1.1   | V                |
| $r_{CE}$        | $V_{GE} = 15\text{ V}$                                       | $T_j = 25\text{ °C}$  | 3.3  | 4.2   | $\text{m}\Omega$ |
|                 |  | $T_j = 125\text{ °C}$ | 5.2  | 6.0   | $\text{m}\Omega$ |
| $V_{GE(th)}$    | $V_{GE} = V_{CE}, I_C = 12\text{ mA}$                        | 5.2                   | 5.8  | 6.4   | V                |
| $I_{CES}$       | $V_{GE} = 0\text{ V}$<br>$V_{CE} = 1700\text{ V}$            | $T_j = 25\text{ °C}$  |      | 3     | $\text{mA}$      |
|                 |  | $T_j = 125\text{ °C}$ |      |       | $\text{mA}$      |
| $C_{ies}$       | $V_{CE} = 25\text{ V}$                                       |                       | 26.4 |       | nF               |
| $C_{oes}$       | $V_{GE} = 0\text{ V}$  |                       | 1.10 |       | nF               |
| $C_{res}$       |  |                       | 0.88 |       | nF               |
| $Q_G$           | $V_{GE} = -8\text{ V...} + 15\text{ V}$                      |                       | 2800 |       | nC               |
| $R_{Gint}$      | $T_j = 25\text{ °C}$   |                       | 2.50 |       | $\Omega$         |
| $t_{d(on)}$     | $V_{CC} = 1200\text{ V}$<br>$I_C = 300\text{ A}$             | $T_j = 125\text{ °C}$ | 340  |       | ns               |
| $t_r$           | $V_{GE} = \pm 15\text{ V}$                                   | $T_j = 125\text{ °C}$ | 75   |       | ns               |
| $E_{on}$        | $R_{Gon} = 4\text{ }\Omega$                                  | $T_j = 125\text{ °C}$ | 180  |       | mJ               |
| $t_{d(off)}$    | $R_{Goff} = 4\text{ }\Omega$                                 | $T_j = 125\text{ °C}$ | 900  |       | ns               |
| $t_f$           |  | $T_j = 125\text{ °C}$ | 105  |       | ns               |
| $E_{off}$       |  | $T_j = 125\text{ °C}$ | 110  |       | mJ               |
| $R_{th(j-c)}$   | per IGBT   |                       |      | 0.073 | K/W              |

# SEMiX452GB176HDs



SEMiX® 2s

## Trench IGBT Modules

### SEMiX452GB176HDs

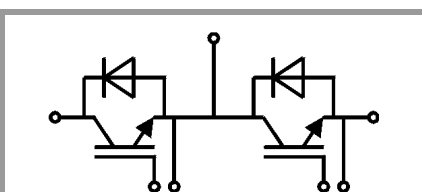
#### Features

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| Characteristics          |  |                       |      |                |      |      |
|--------------------------|--|-----------------------|------|----------------|------|------|
| Symbol                   | Conditions   |                       | min. | typ.           | max. | Unit |
| <b>Inverse diode</b>     |  |                       |      |                |      |      |
| $V_F = V_{EC}$           | $I_F = 300\text{ A}$<br>$V_{GE} = 0\text{ V}$<br>chip          | $T_j = 25\text{ °C}$  |      | 1.7            | 1.90 | V    |
|                          |  | $T_j = 125\text{ °C}$ |      | 1.7            | 1.9  | V    |
| $V_{F0}$                 |  | $T_j = 25\text{ °C}$  | 0.9  | 1.1            | 1.3  | V    |
|                          |  | $T_j = 125\text{ °C}$ | 0.7  | 0.9            | 1.1  | V    |
| $r_F$                    |  | $T_j = 25\text{ °C}$  | 2.0  | 2.0            | 2.0  | mΩ   |
|                          |  | $T_j = 125\text{ °C}$ | 2.7  | 2.7            | 2.7  | mΩ   |
| $I_{RRM}$                | $I_F = 300\text{ A}$   | $T_j = 125\text{ °C}$ |      | 360            |      | A    |
| $Q_{rr}$                 | $di/dt_{off} = 4500\text{ A}/\mu\text{s}$                      | $T_j = 125\text{ °C}$ |      | 85             |      | μC   |
| $E_{rr}$                 | $V_{GE} = -15\text{ V}$<br>$V_{CC} = 1200\text{ V}$            | $T_j = 125\text{ °C}$ |      | 46             |      | mJ   |
| $R_{th(j-c)}$            | per diode  |                       |      |                | 0.15 | K/W  |
| <b>Module</b>            |  |                       |      |                |      |      |
| $L_{CE}$                 |  |                       |      | 18             |      | nH   |
| $R_{CC'+EE'}$            | res., terminal-chip  | $T_C = 25\text{ °C}$  |      | 0.7            |      | mΩ   |
|                          |  | $T_C = 125\text{ °C}$ |      | 1              |      | mΩ   |
| $R_{th(c-s)}$            | per module   |                       |      | 0.045          |      | K/W  |
| $M_s$                    | to heat sink (M5)  |                       | 3    |                | 5    | Nm   |
| $M_t$                    |  | to terminals (M6)     | 2.5  |                | 5    | Nm   |
|                          |  |                       |      |                |      | Nm   |
| $w$                      |  |                       |      |                | 250  | g    |
| <b>Temperatur Sensor</b> |  |                       |      |                |      |      |
| $R_{100}$                | $T_c = 100\text{ °C}$ ( $R_{25} = 5\text{ k}\Omega$ )          |                       |      | $493 \pm 5\%$  |      | Ω    |
| $B_{100/125}$            | $R(T) = R_{100} \exp[B_{100/125}(1/T - 1/T_{100})]$ ; $T[K]$ ; |                       |      | $3550 \pm 2\%$ |      | K    |



GB

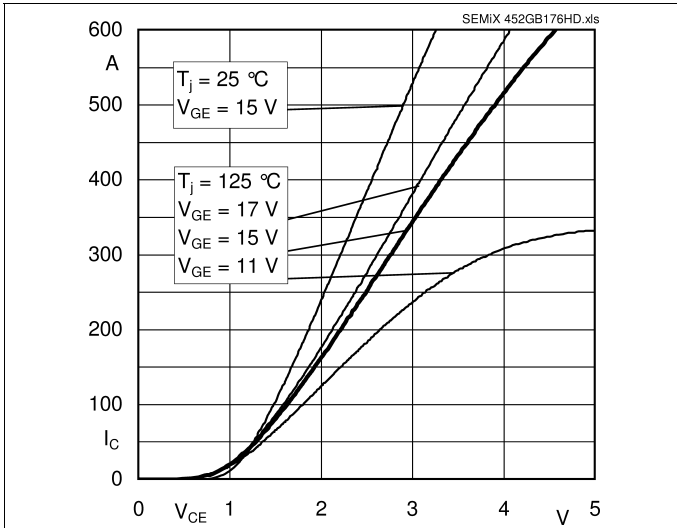


Fig. 1: Typ. output characteristic, inclusive  $R_{CC+EE}$

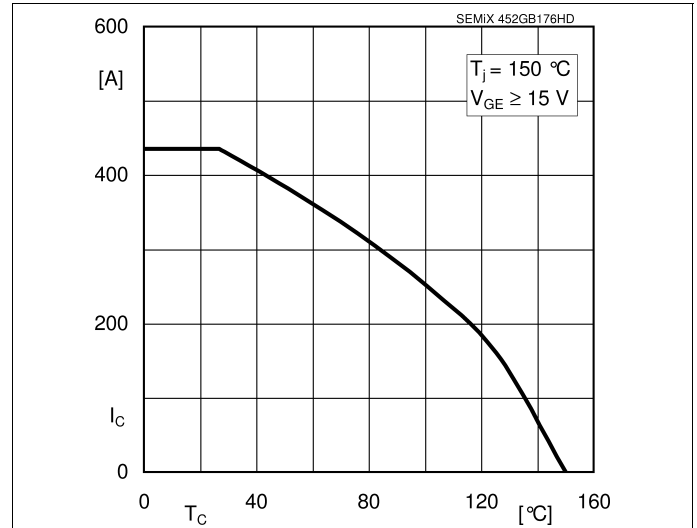


Fig. 2: Rated current vs. temperature  $I_C = f(T_C)$

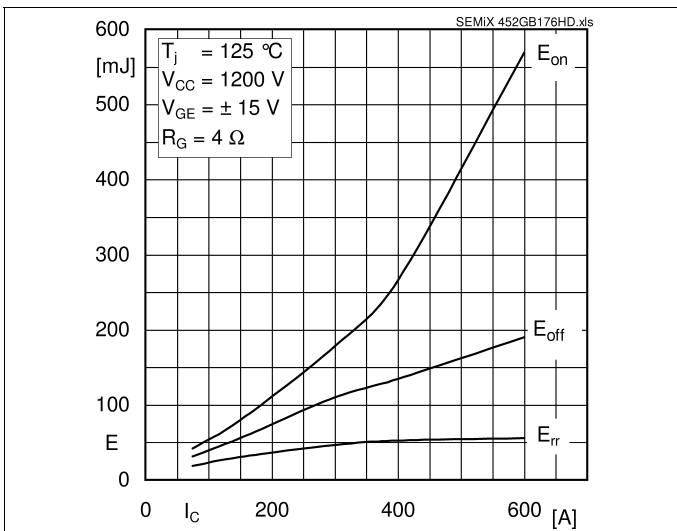


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$

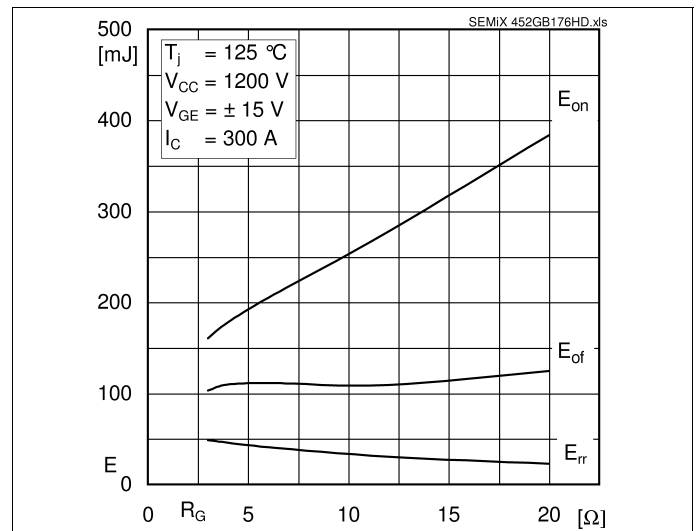


Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$

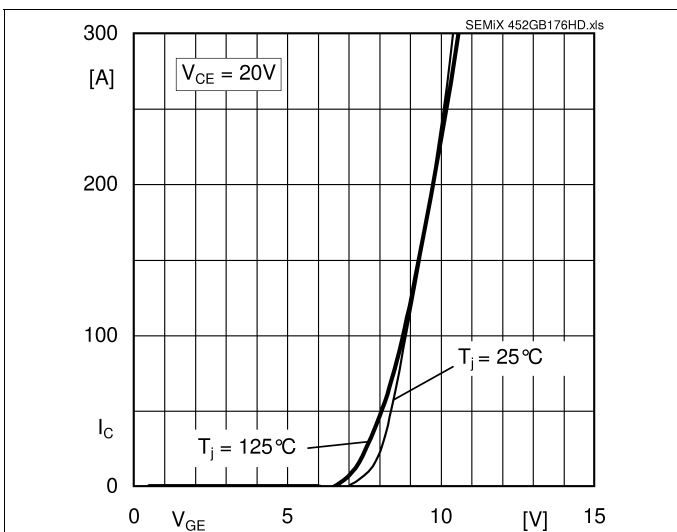


Fig. 5: Typ. transfer characteristic

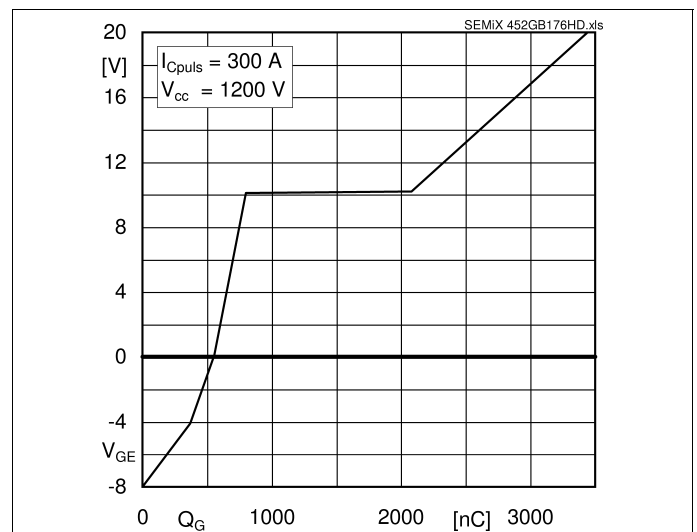
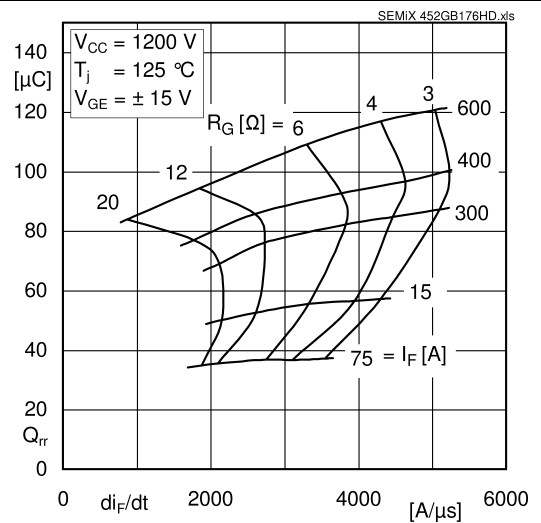
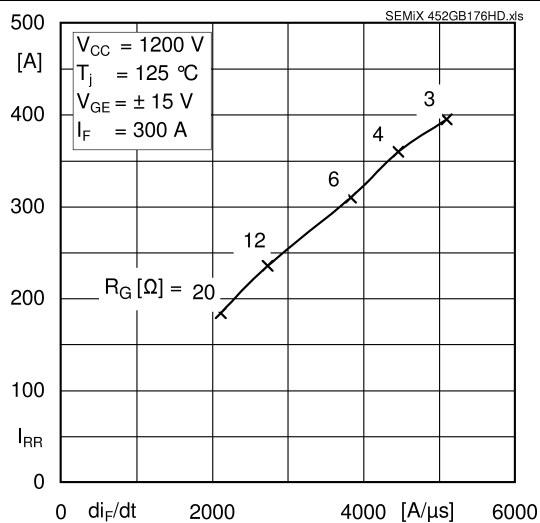
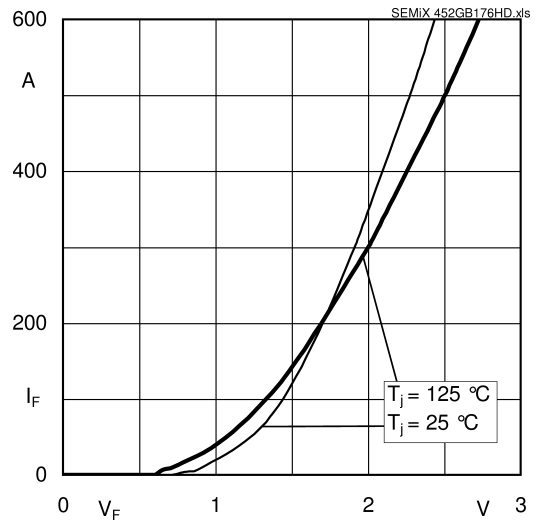
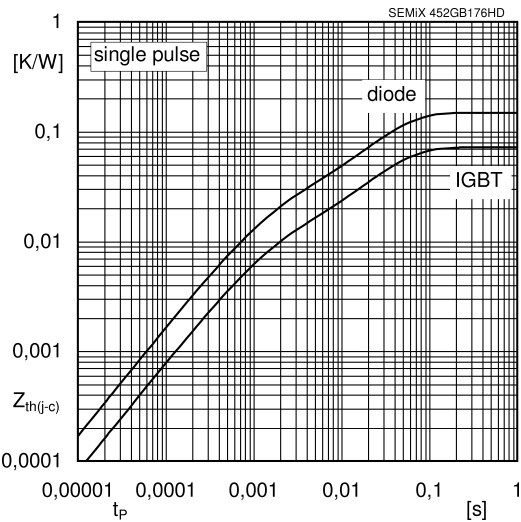
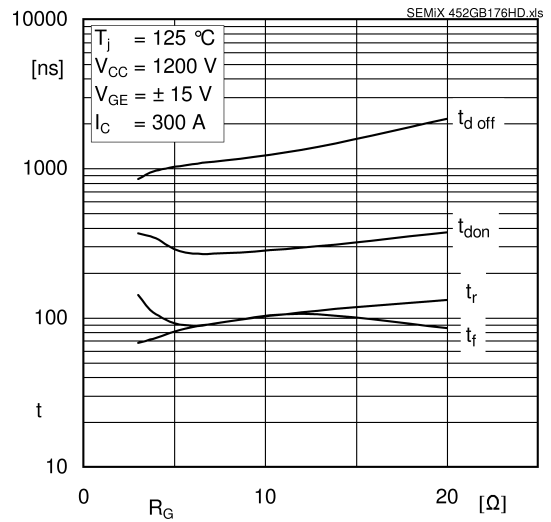
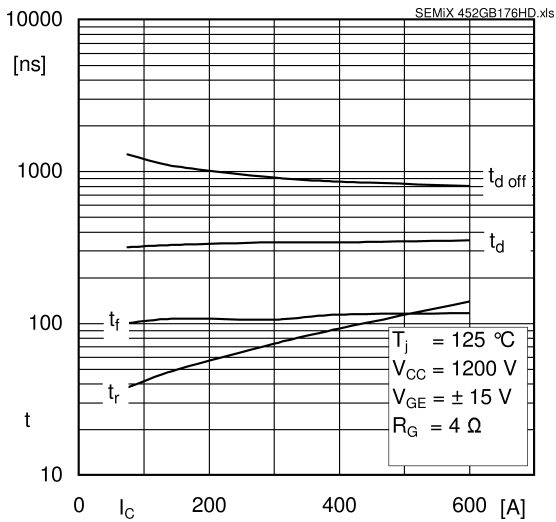
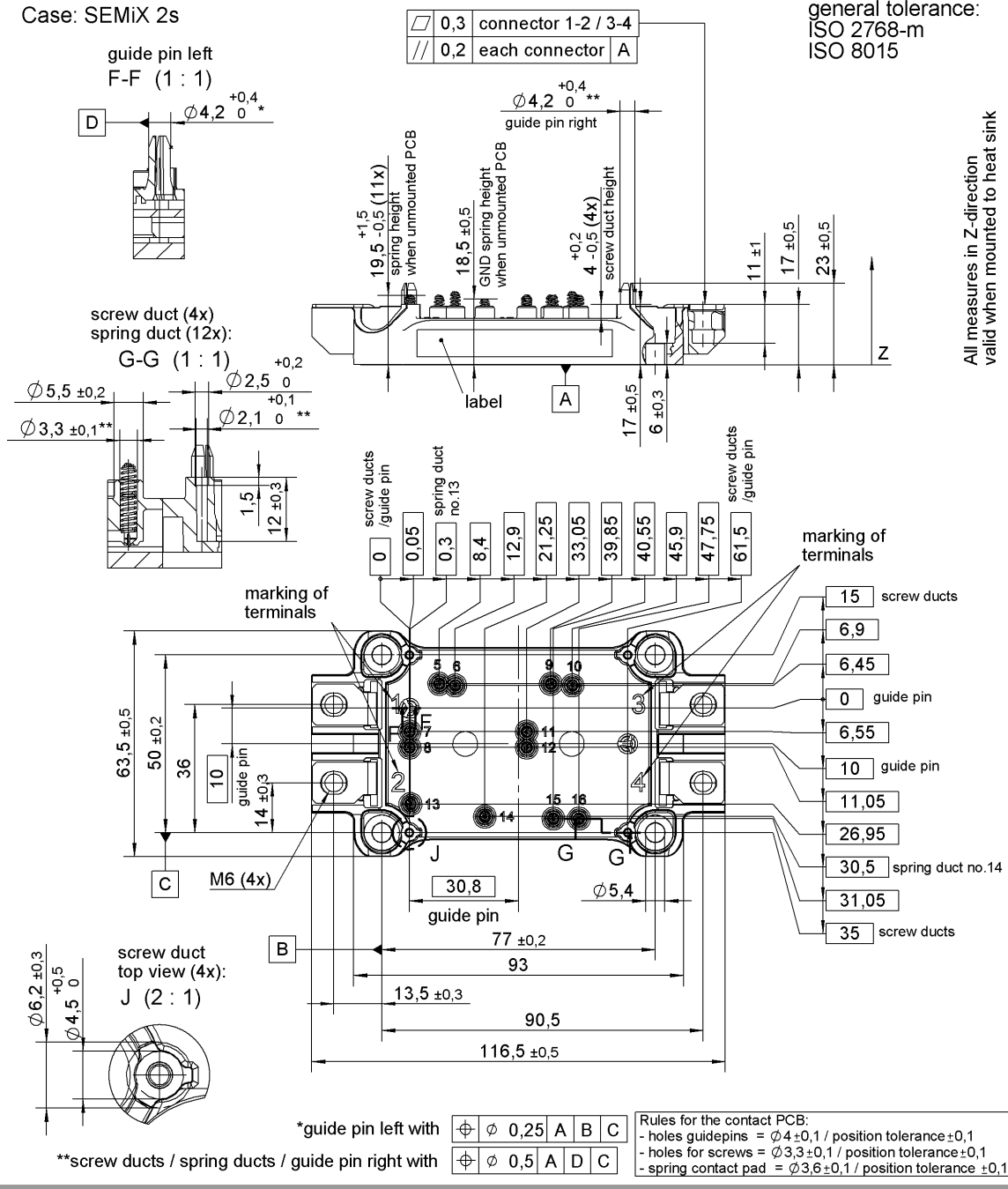


Fig. 6: Typ. gate charge characteristic

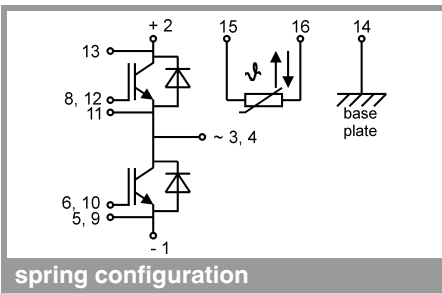


# SEMiX452GB176HDs

Case: SEMiX 2s



SEMIX 2s



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.